

## TYPE AND VOLTAGE

W-TYPE :	UL and CSA type	120V AC
E-TYPE :	NK-STD type	220V AC
B-TYPE :	BS type	240V AC

# SERVICE MANUAL

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## SPECIFICATIONS

### AMPLIFIER SECTION

#### Continuous Power Output per Channel:

20~20k Hz (8Ω)	>220 Watts
20~20k Hz (4Ω)	>240 Watts
1kHz (8Ω)	>240 Watts
1kHz (4Ω)	>240 Watts

#### T. H. Distortion, 8Ω:

at Continuous Power Output	≧0.008%
at 1 Watt Power Output	≧0.02%

#### T. H. Distortion, 4Ω:

at Continuous Power Output	≧0.02%
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#### I. M. Distortion, 8Ω:

at Continuous Power Output	≧0.01%
at 1 Watt Power Output	≧0.02%

IHF Power Bandwidth, 8Ω: 10Hz~700kz

Damping Factor at 1kHz, 8Ω: >80

### Frequency Response

"NORMAL" input, 8Ω: 20Hz~100kHz +0, -1dB  
at 1 Watt Power Output

#### Input Sensitivity for 300 Watts Power Output:

MAIN IN 1V ±2dB

Signal to Noise Ratio, IHF A" Network:

MAIN (NORMAL, DIRECT) >115dB

#### Signal to Noise Ratio, DIN Filter:

MAIN IN (NORMAL, DIRECT) >90dB

Channel Balance: ≧1dB

Residual Hum & Noise, 8Ω: ≧0.4 mV

Idling Current: 50~150mA

Midpoint Voltage: 0 ±30mV

Muting Delay Time: 2 ~ 7 seconds

### GENERAL

#### Power Requirement:

W-TYPE AC 120V, 60Hz

E-TYPE AC 220V, 50Hz

B-TYPE AC 240V, 50Hz

Power Consumption: 800W (1.25kVA)

Ambient Temperature during Operation: -10~30°C

#### Dimensions:

Width 482 mm (19 inches)

Height 182 mm (7¼ inches)

Depth 460 mm (18⅞ inches)

Weight, without package: 21.5kg (47.3 lbs)

\*Specifications are subject to change without notice.

## DISASSEMBLY

### Cabinet Cover Removal

- Remove 6 tapping screws from the top of the unit.
- Remove four screws from both sides of the unit.
- Lift the cabinet cover away from the unit.

### Bottom Plate Removal

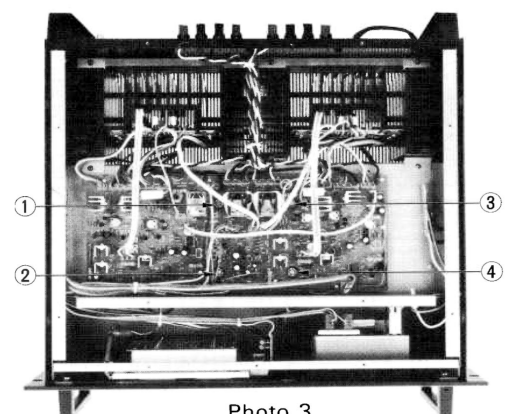
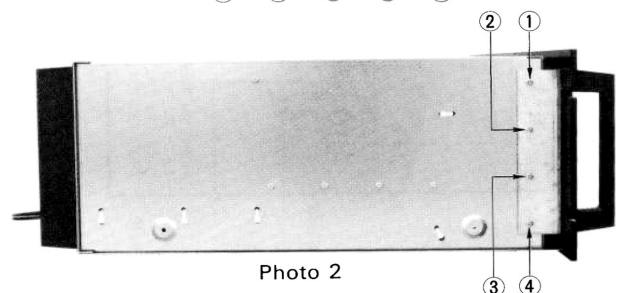
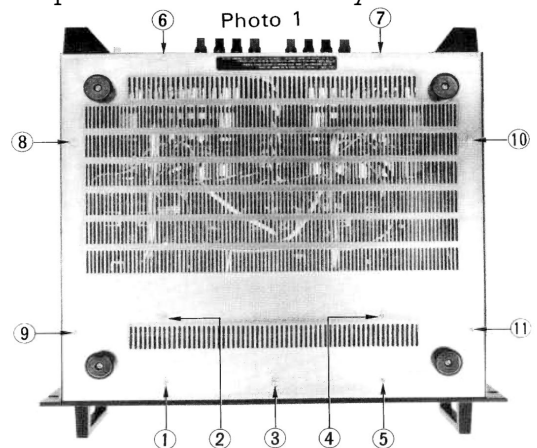
- Remove 11 tapping screws (#1- #11) from the bottom of the unit as shown in Photo 1.
- Lift the bottom plate away from the unit.

### Front Panel Removal

- Remove 4 tapping screws (#1- #4) from the left side of the unit as shown in Photo 2.
- Similarly remove 4 tapping screws from the right side of the unit.
- Remove the front panel away from the unit by pulling it forward.

### Power Transformer Removal

- Remove the cabinet cover & the bottom plate.
- Disconnect all the cables from the power transformer.
- Remove 4 nuts (#1- #4) from the chassis as shown in Photo 3.
- Lift the power transformer away from the unit.



## CIRCUIT DESCRIPTION

NIKKO's ALPHA 450, adopting latest devices such as Hi- $f_T$  power transistors, is of a design introducing a variable bias circuit (non-switching circuit), a DC servo circuit & other most advanced techniques.

The following are explanations of the main circuits & devices.

### Variable Bias Circuit

Currently, in the output stage of power amplifiers are mostly used SEPP (Single Ended Push Pull) circuits. (Fig. 2).

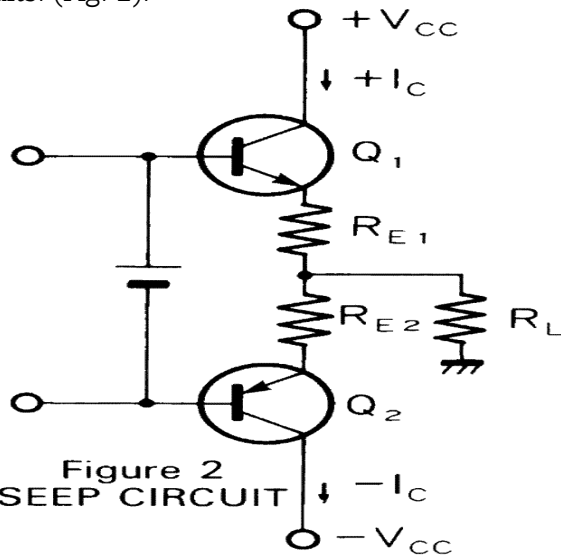


Figure 2  
SEPP CIRCUIT

It is generally known that the current (idle current) flowing through NPN & PNP transistors of this circuit can be classified into three large groups of operation form, class "A", class "AB" & class "B". (Fig. 3).

In class "A" operation, neither of collector currents,  $Q_1$  &  $Q_2$  becomes zero nor cut off. Even when the current flowing to the load  $R$  is zero, a certain current is flowing through  $Q_1$  &  $Q_2$  & so no crossover distortion exists theoretically.

To realise perfect class "A" operation, however, a current equal to or more than maximum output should continue to be let flow at the output stage as idle current, causing class "A" operation to prove to be a poor efficiency system.

In class "AB" or "B" operation, the  $Q_1$  plays the role of amplification of the plus part of the signal &  $Q_2$  that of the minus part, no matter whether idle current is large or small.

In other words, there definitely exists a period in which, when one transistor is on, the other transistor keeps cutting off, in these operations.

Switching distortion or crossover distortion is caused at the moment of this active status turning into cut-off status or the cut-off status into the active status.

Nevertheless, as these operation forms have high efficiency with small idle current, it is much easier to use class "AB" or B operation for high power amplification rather than class "A".

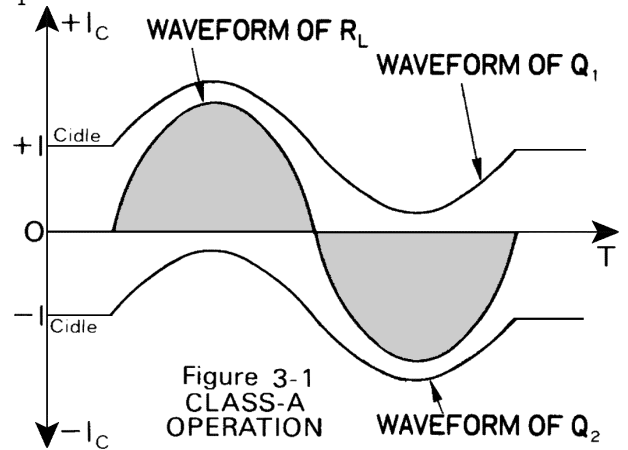


Figure 3-1  
CLASS-A  
OPERATION

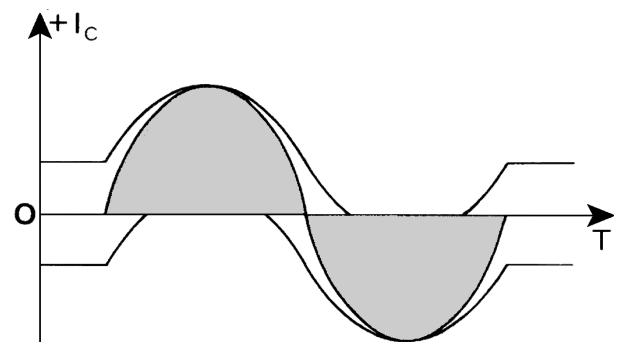


Figure 3-2  
CLASS-AB  
OPERATION

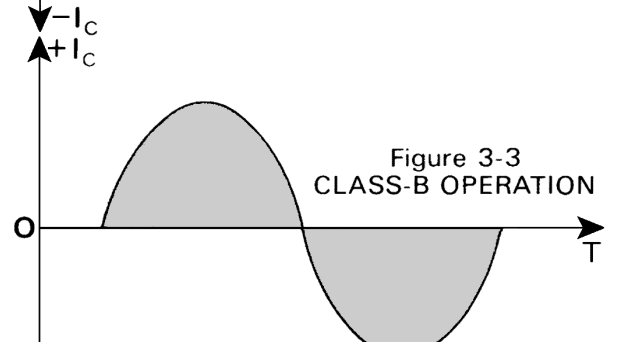


Figure 3-3  
CLASS-B  
OPERATION

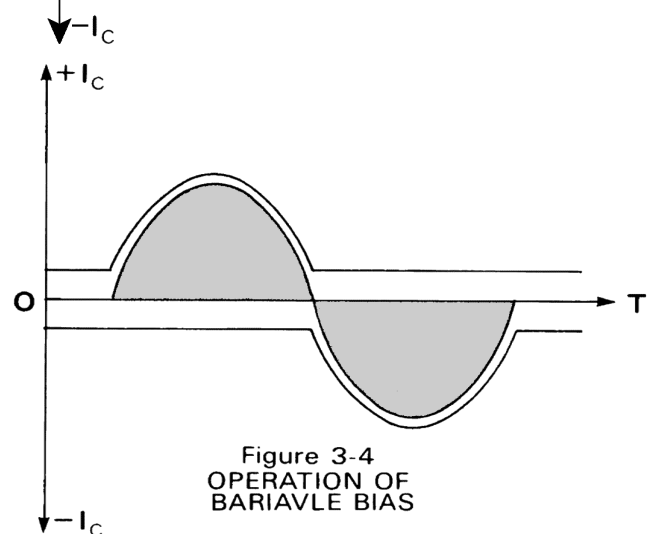
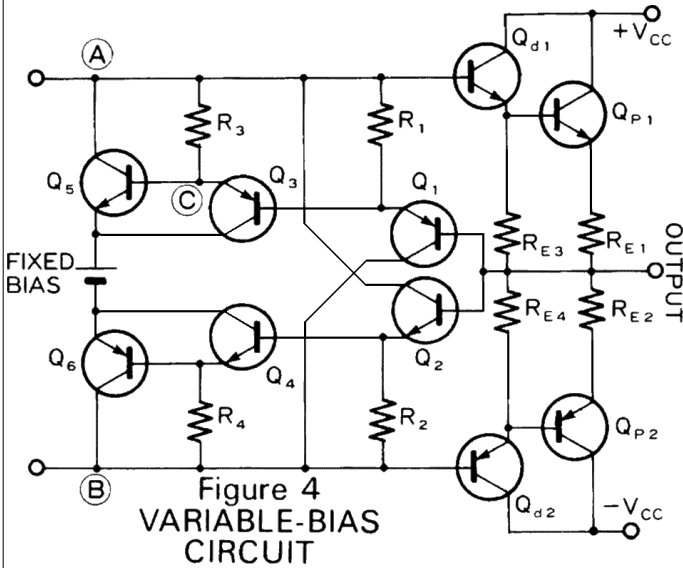


Figure 3-4  
OPERATION OF  
VARIABLE BIAS

A power amplifier enjoying the merit of each of these systems — that is, practically no crossover or switching distortion being caused in class "A" operation & easier high power amplification being achieved by class "B" — has been realised by adopting the variable bias circuit.

The idea of a variable bias circuit is -that in no case the output stage is allowed to be cut-off by increasing & decreasing bias voltage in corresponding with the voltage of input signal.

Fig. 4 shows the variable bias circuit adopted in ALPHA 450.



Now, suppose the + wave (plus part) of signal has been inputted, the currents of  $Q_{p1}$  &  $Q_{d1}$  increase & the voltage at both ends of  $R_{E1}$  &  $R_{E3}$  become high, resulting in a rise in the voltage between point (A) & OUTPUT. '

At that time, the voltage at both ends of  $R_1$  &  $R_3$  becomes high because current flows  $R_1 > Q_1$  &  $R_3 > Q_3$ , causing the potential at (C) point to lower & the voltage of  $Q_5$  between collector & emitter to rise. As a result, the voltage between A & (B) rises &  $Q_{p2}$ , &  $Q_{d2}$  is kept from being cut-off.

From another point of view, the voltage drops at the emitter resistors  $R_{E1}$  &  $R_{E3}$  (these resistors are indispensable to protect transistors in stabilising bias of the output stage or at the time of abnormal current flowing) are cancelled by the drops at  $R_1$  &  $R_4$ , thus protecting  $Q_{p2}$  &  $Q_{d2}$  from becoming zero or anti-bias.

In the same manner, when the -wave (-part) of signal has been inputted, current flows  $Q_2 > R_2$  &  $Q_4 > R_4$ , resulting in a rise of  $V_{CE}$  at  $Q_6$ , thus protecting  $Q_{p1}$  &  $Q_{d1}$  from being cut-off.

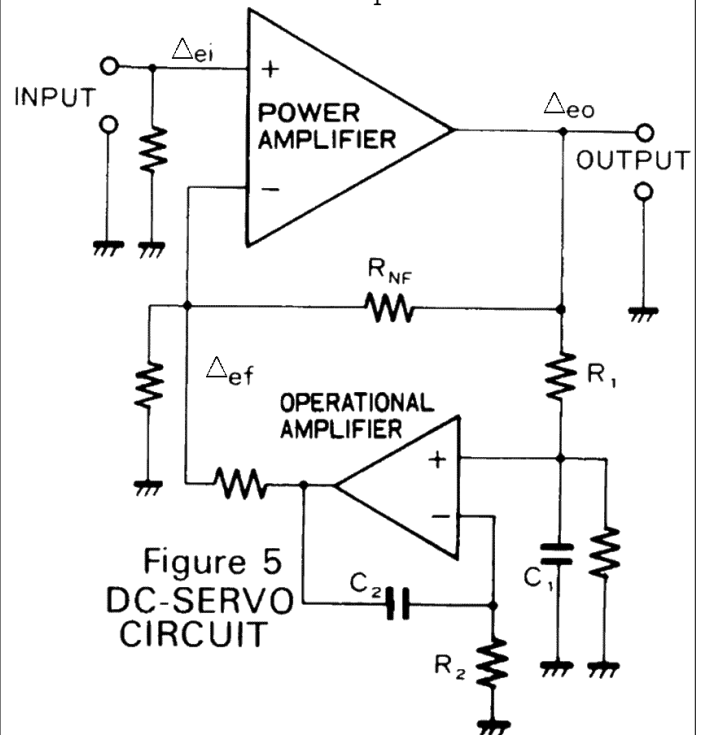
### DC Servo Circuit

DC amplification is the most advanced form adopted for audio amplifiers as there is no phase lag over all the range from DC to audio frequency.

However, in a perfect DC amplifier (which is an amplifier having no coupling capacitors in its input part & NFB loop), a DC drift is caused in case a direct current is inputted or when the DC balance between each element has been lost due to temperature rise inside the amplifier.

The DC servo circuit is to suppress such a drift & realise a more stabilised amplifier.

The principle of a DC servo circuit is something like that of a comparator, in which changes in DC current between the output point & the ground is detected & drifts of the amplifier is controlled with their results used as the output of the servo circuit.



The basic elements are an integrating circuit composed of  $C_1$  &  $R_1$ , an operational amplifier & a mirror integrator composed of  $C_2$  &  $R_2$ . (Fig. 5).

Now, suppose a drift  $\Delta eo$  has been caused at the output of the power amplifier, a potential with the same phase  $\Delta ef$  is outputted at the output of the operational amplifier.

On the other hand, the initial stage of the power amplifier is a differential amplifier. When  $\Delta ef$  is inputted at its inverting input, the potential at the non-inverting input  $\Delta ei$  changes in the opposite direction of  $\Delta ef$ , resulting in a decrease of drift at the output of the power amplifier.

The DC servo circuit has a specific frequency characteristic. In the range of DC & ultra low frequency, gain of the power amplifier is kept at one over several tens of decibel, & in the audio frequency band, amplification at a certain gain can be made in the same manner as ordinary power amplifier.

The frequency on which the DC servo circuit starts to have effects is determined by the four elements,  $C_1$ ,  $R_1$ ,  $C_2$  &  $R_2$ .

### Hi- $f_T$ Power Transistors

For details characteristics, refer to "SEMICONDUCTOR DATA" at the end of this manual.

The power transistors employed in ALPHA 450 realise an  $f_T$  (Current Gain-bandwidth Product) of 80MHz with NPN type & 60MHz with PNP type (each being a typical value) in spite of its high  $P_c$  (Collector Power Dissipation) such as 150W (The value when  $T_c = 25^\circ\text{C}$ ). Compared with conventional transistors with a  $P_c$  of 150W where  $f_T$  was around 10MHz at maximum, the high speed attained by these Hi- $f_T$  power transistors is remarkable.

Such high  $f_T$  has been realised specially by the inside construction of these transistors which is greatly different from that of conventional ones — the multi-emitter construction.

In this construction, the emitter inside the transistor is divided into many units & emitter resistors with small resistance are inserted to each unit, resulting in a parallel connection.

This equivalently means that many small signal transistors with high  $f_T$  & switching speed are connected in parallel, which has made it possible to realise such a high power characteristic while maintaining high switching speed.

Thanks to such construction as mentioned above, these power transistors are excellent in linearity of its  $h_{fe}$ .

Furthermore, as dissipation is dispersed equally to each emitter due to the emitter-divided construction, they have another feature of being strong against breakdown as compared with conventional power transistors.

### ALIGNMENT

#### Alignment Precautions

1. As the ALPHA 450 is a power amplifier with large output power, it consumes much electrical power & a great amount of current flows in the power source line of the primary side. Therefore, in the case when it is connected to the source by an extension cord, the size of the extension cord should be equal or larger than that of the power source cord of the ALPHA 450. Otherwise, the voltage might be reduced or the extension cord might generate excessive heat because of the resistance which the cord has, then not only can proper alignment be done, but also it is very dangerous.

2. If the power sources are supplied to the ALPHA 450 & the instruments by branching off from one cord, the voltage is sometimes dropped down & the stability of the instruments goes down. The ALPHA 450 & the instruments should be connected to the power sources by using independent cords. The ALPHA 450 must take the power source from AC outlet of the wall side.
3. As there are many parts which hold high voltages in the circuit & the parts inside of the ALPHA 450, be careful not to receive an electric shock. In the case of connecting & taking off the instruments, you must turn off the power switch of the ALPHA 450 before getting on the work.
4. When the circuit happens to be shorted by the drivers or test probes used for alignment through mistake, the circuit & the parts will be damaged. As the damage is larger than that of ordinary amplifiers & receivers, close attention is needed. It is advised that the screw driver, excluding the top part, should be wrapped with insulation tape or a driver made of plastic or some kind of insulating material should be used.
5. As the dummy load resistor generates heat while alignment, it gets very hot & you may be burnt if you touch it with bare hands. It's better if you can put the dummy load resistor in a place away from being touched, but the wire between the dummy load resistor & the amplifier should not be long. Conceive some method, like putting the dummy load resistor in a well ventilated box. Further, as  $>10\text{A}$  current might flow in the wire connecting the dummy load resistor & the amplifier, at least larger than AWG #18 thick wire should be used.
6. The slide switch near the "INPUT LEVEL" volume on the rear panel of the amplifier is to be set in the "NORMAL" position. All the adjustments in the following should be done after the slide switch is set in the "NORMAL" position.

#### Test Equipment

Allow a minimum of 10 minutes warm-up for test equipment.

Maintain rated line voltage.

Audio Frequency Generator

Distortion Meter

Oscilloscope

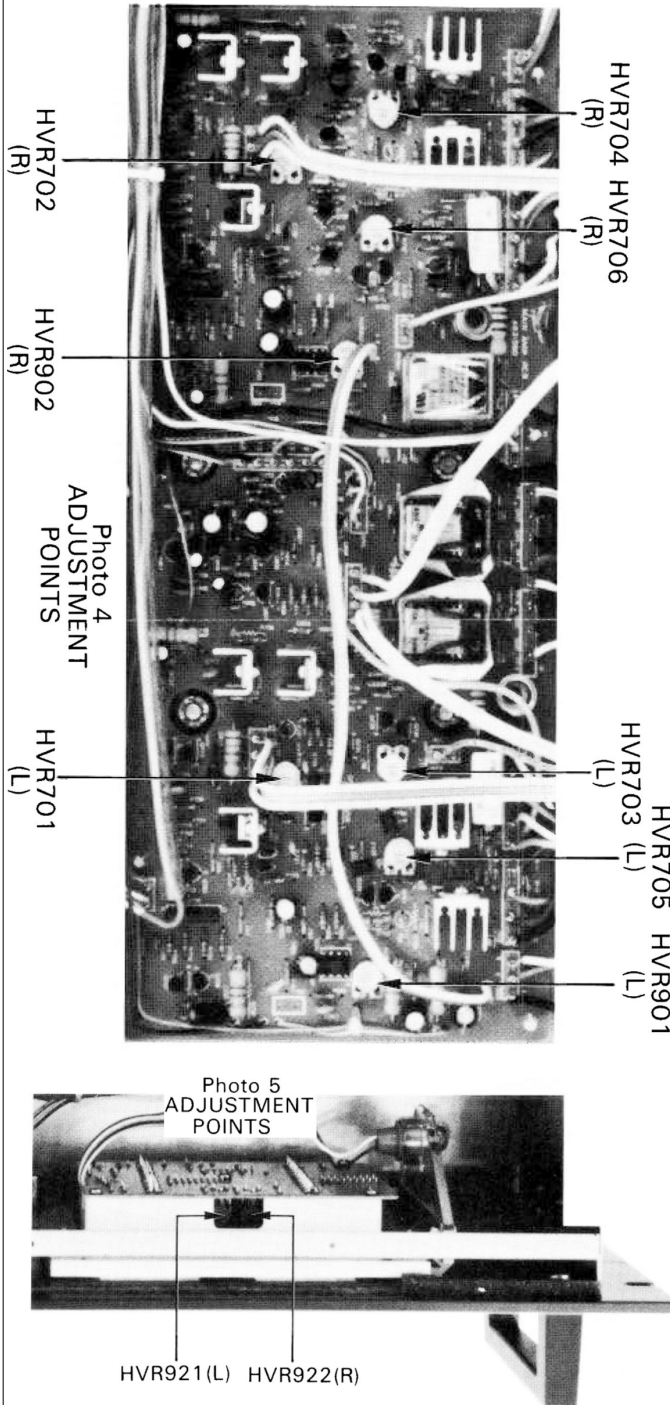
AC Voltmeter

DC Voltmeter

2-Dummy Load Resistors,  $8\Omega$ , 500W

2-Dummy Load Resistors,  $4\Omega$ , 500W

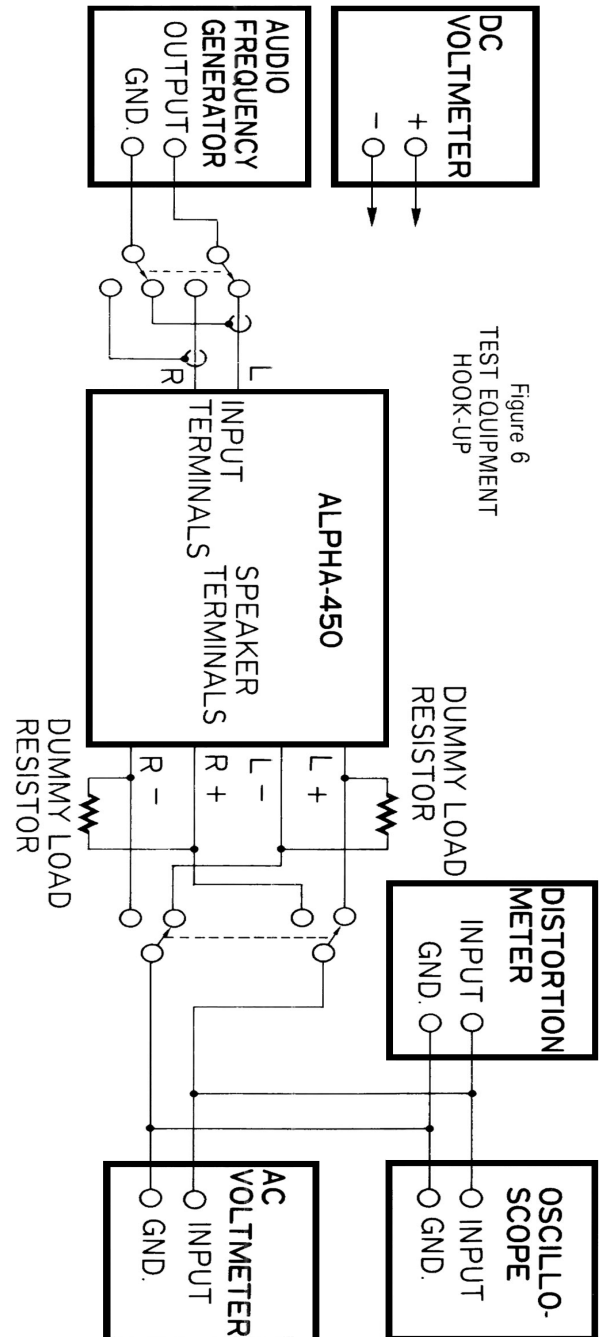
All the semi fixed resistors of the MAIN AMP PCB are set around the centre position temporarily. (HVR701~706, HVR901 & HVR902)



### DC BALANCE ADJUSTMENT

1. Connect 8Ω dummy load resistors to the left & right channel speaker terminals.
2. Turn the "INPUT LEVEL" volume controls down to the fully counter clockwise, & set it to "MIN".
3. Turning on the power switch of the ALPHA 450.
4. Adjust the semi-fixed resistor R901 (left-ch) or R902 (right-ch) for a 0V ±5mV on DC voltmeter.
5. Turning on the power switch, till the DC balance settled down. This takes about 10 minutes. So after adjustment, keep the power switch for 10 minutes, then make sure the DC balance again.
6. Turning off the power switch. Remove the DC voltmeter & 8Ω dummy load resistors.

### LIMITER CIRCUIT ADJUSTMENT



NOTE: Fig 6, for test equipment hook-up.

1. Connect 4Ω dummy load resistors to the left & right channel speaker terminals.
2. Connect the AC voltmeter, distortion meter & the oscilloscope to the left (right) channel speaker terminals. Connect the generator to left (right) channel input terminal.
3. Turning on the power switch of the ALPHA 450.
4. Turn the "INPUT LEVEL" volume control fully clockwise, & set it to "MAX".
5. Set the frequency of the generator to 1kHz. Adjust the output level of the generator so as to make the output power 260W. (32.5VAC voltmeter reading.)
6. Adjust the semi-fixed resistors HVR703~HVR706 so that the upper & the lower side peaks of the output waveform begin to clip. (HVR703 & 705 are for the left-ch, HVR704 & 706 for the right.)
7. Turning off the power switch. Remove 4Ω dummy load resistors.

## IDLING CURRENT ADJUSTMENT

1. Connect the 8Ω dummy load resistors to the left & right-ch speaker terminals. Connect the DC voltmeter across the wiring terminals No. 16 & 17 (left-ch) or No. 35 & 36 (right-ch on the MAIN AMP PCB).
2. Turning on the power switch of the ALPHA 450. Adjust the semi fixed resistor HVR701 (left-ch) or HVR702 (right-ch) so that the DC voltmeter indicates 18mV ±1mV.
3. Turn off the power switch of the ALPHA 450 & remove the DC voltmeter & 8Ω dummy load resistors.

## POWER LEVEL INDICATOR ADJUSTMENT

NOTE: Fig 6, for test equipment hook-up.

1. Connect 8Ω dummy load resistors to the left & right-ch speaker terminals.
2. Connect the AC voltmeter, distortion meter & the oscilloscope to the left (right) channel speaker terminals. Connect the generator to left (right) channel input terminal.
3. Turning on the power switch of the ALPHA 450.
4. Turn the "INPUT LEVEL" volume control fully clockwise, & set it to "MAX".
5. Set the frequency of the generator to 1kHz. Adjust the output level of the generator so as to make the output power 170W. (37VAC voltmeter reading.)
6. Adjust the semi-fixed resistors HVR921 (left-ch) & HVR922 (right-ch) of the LEVEL INDICATOR PCB so that the LED of "200W" dimly lights up.
7. Turning off the power switch of the ALPHA 450.
8. Remove all test equipment.

## Power Transistors Mounting Assembly

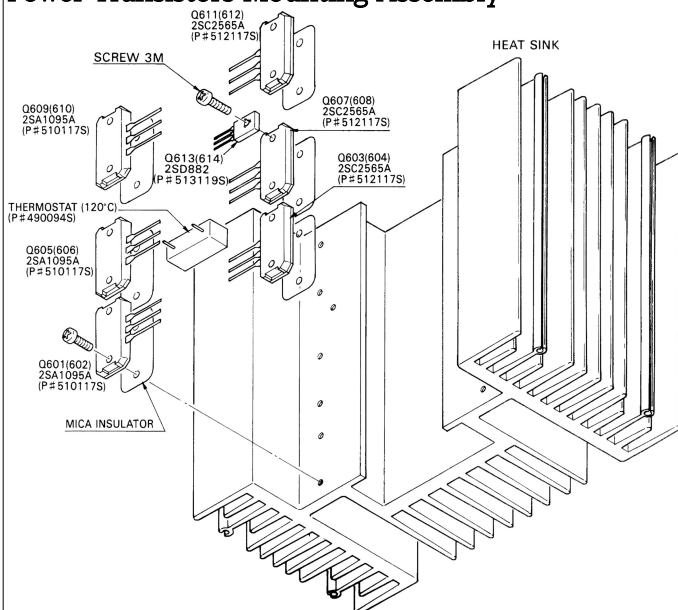
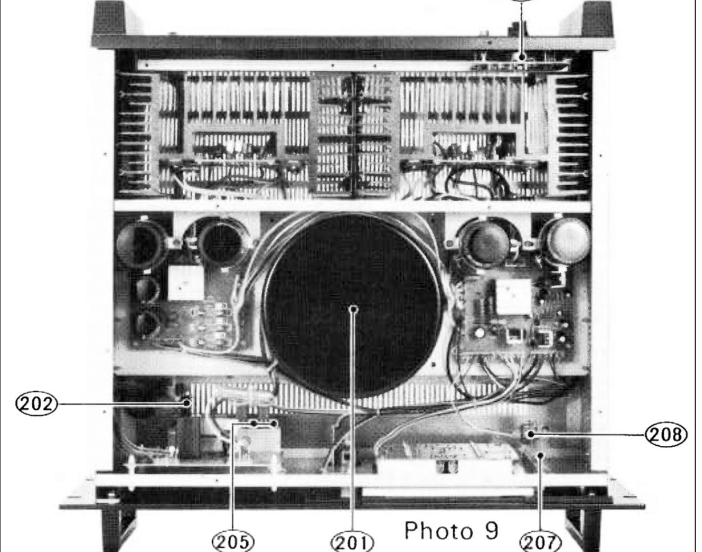
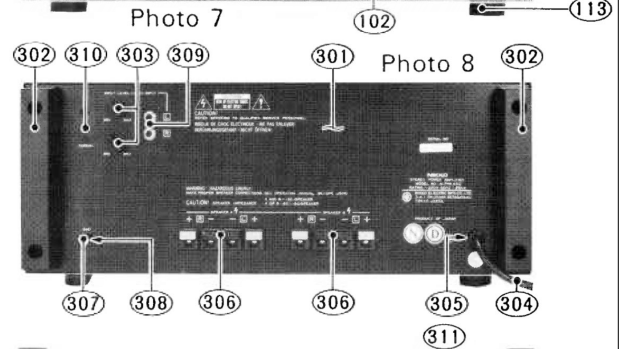
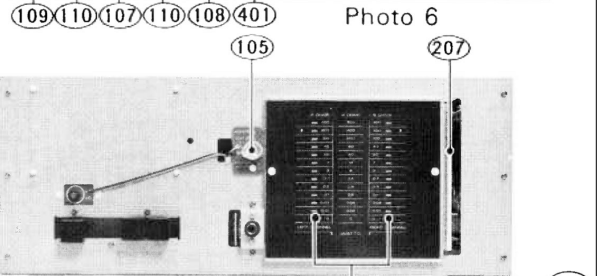
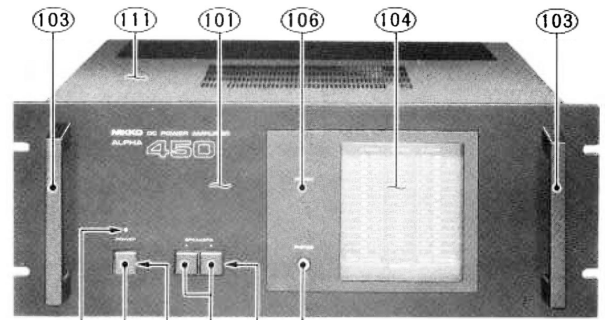


Figure 9 NOTE: For best heat conduction, use thermally conductive silicon grease between the power transistor and the mica insulator and between the insulator and the heat sink.

## Parts Locations



### Precautions For Repair Service

Many of these items are included just as a reminder — they are normal procedures for experienced technicians. Short-cuts can be taken: but, often they cause additional damage to transistors, circuit components or the printed circuit board.

1. Do not bridge electrolytic capacitors with AC power. The resultant surges may damage solid state devices.
2. Do not bias the base of any transistor while voltage is being applied to its collector.
3. Replacements for output and driver transistors, if necessary, must be made from the same hfe group as the original type. Be sure to include this information when ordering replacement transistors.
4. If one output transistor burns out (open or shorts), always remove all output transistors in that channel and check the bias adjustment, the control and other parts in the network with an ohmmeter before inserting a new transistor. All output transistors in one channel will be destroyed if the base biasing circuit is open in the emitter end.

### SAFETY INSTRUCTIONS

#### \* PRECAUTIONS DURING SERVICING

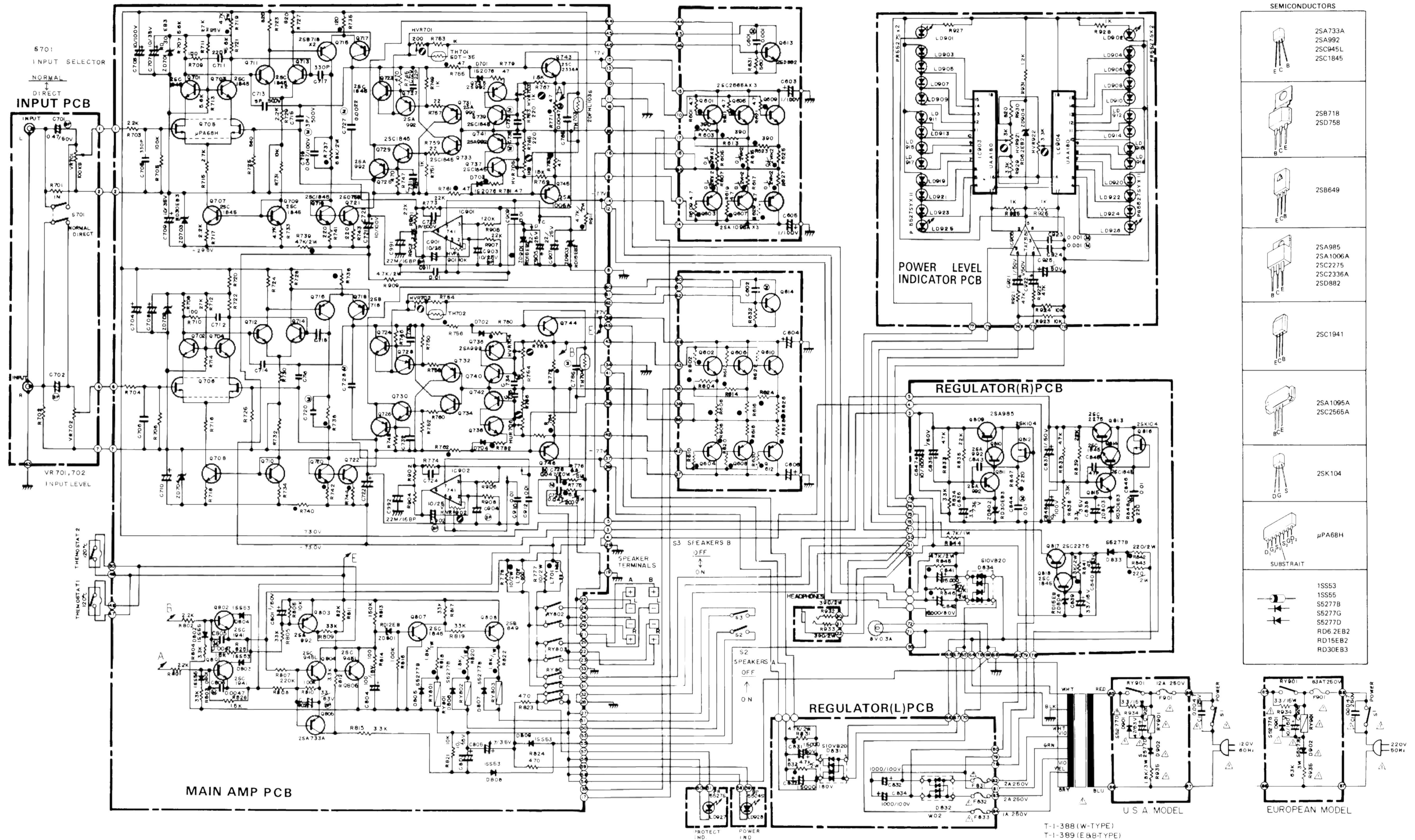
1. Parts identified by the symbol parts are critical for safety. Replace only with same parts number specified.
2. Other parts and assemblies are specified for conformance with such regulations as those applying to spurious radiation. These must also be replaced only with replacements.  
Examples : RF converters, tuner units, RF cables, noise blocking capacitors, noise blocking filters, etc.
3. Use specified internal wiring
  - a) Primary leads
  - b) Wires covered with PVC tubing
  - c) Double insulated wire
4. Use specified insulating materials for hazardous live parts.
  - a) Insulation Tape
  - b) Insulated Barriers (Spacers)
  - c) PVC Tubing
  - d) Plastic screws for fixing microswitch (Especially in turntable)
  - e) Terminal stripsWhen replacing the primary components (transformer, power supply cord, switch, switch by-pass capacitor, etc.), wrap ends of wires securely about the terminals before soldering. Where hand soldering is involved a minimum spacing below between terminals of uninsulated live parts of primary or supply circuitry through air or over surface is to be maintained.  
110V, 120V appliance : >3mm spacing  
220V, 240V appliance : >6mm spacing
5. Observe that wires don't contact heat producing parts (heatsinks, oxide metal resistors, rectifiers, etc)
6. Check that replaced wires do not contact sharp edge or pointed parts.
7. Do not remain an electric conductive parts (screws, droplets, etc.) inside the appliance.

#### \* SAFETY RECHECK AFTER SERVICING

Confirm the specified insulation resistance between power plug prongs and externally exposed parts of the appliance is greater than  $10M\Omega$ , but for equipment with external antenna terminals (tuner, receiver, etc.) and is specified insulation resistance should be more than  $2M\Omega$  (ground terminals, in-output jacks, etc.).



# SCHEMATIC DIAGRAM



**NOTES:**

- SCHEMATIC IS SUBJECT TO CHANGE WITHOUT NOTICE.
- RESISTANCE VALUES ARE IN OHMS. K = 1,000; M = 1,000,000.
- CAPACITANCE VALUES 1.0 AND ABOVE ARE IN pF OR  $\mu$ F (P = pF, M =  $\mu$ F), LESS THAN 1.0 ARE IN  $\mu$ F (ELECTROLYTIC CAPACITANCE VALUES ARE IN  $\mu$ F/WV.)
- VOLTAGES ARE MEASURED TO CHASSIS GROUND WITH A "DC VOLT METER".

**SCHEMATIC SYMBOLS:**

- POLYESTER FILM CAPACITOR
- BIPOLAR CAPACITOR
- NONFLAMMABLE RESISTOR

**SERVICE INFORMATION:**

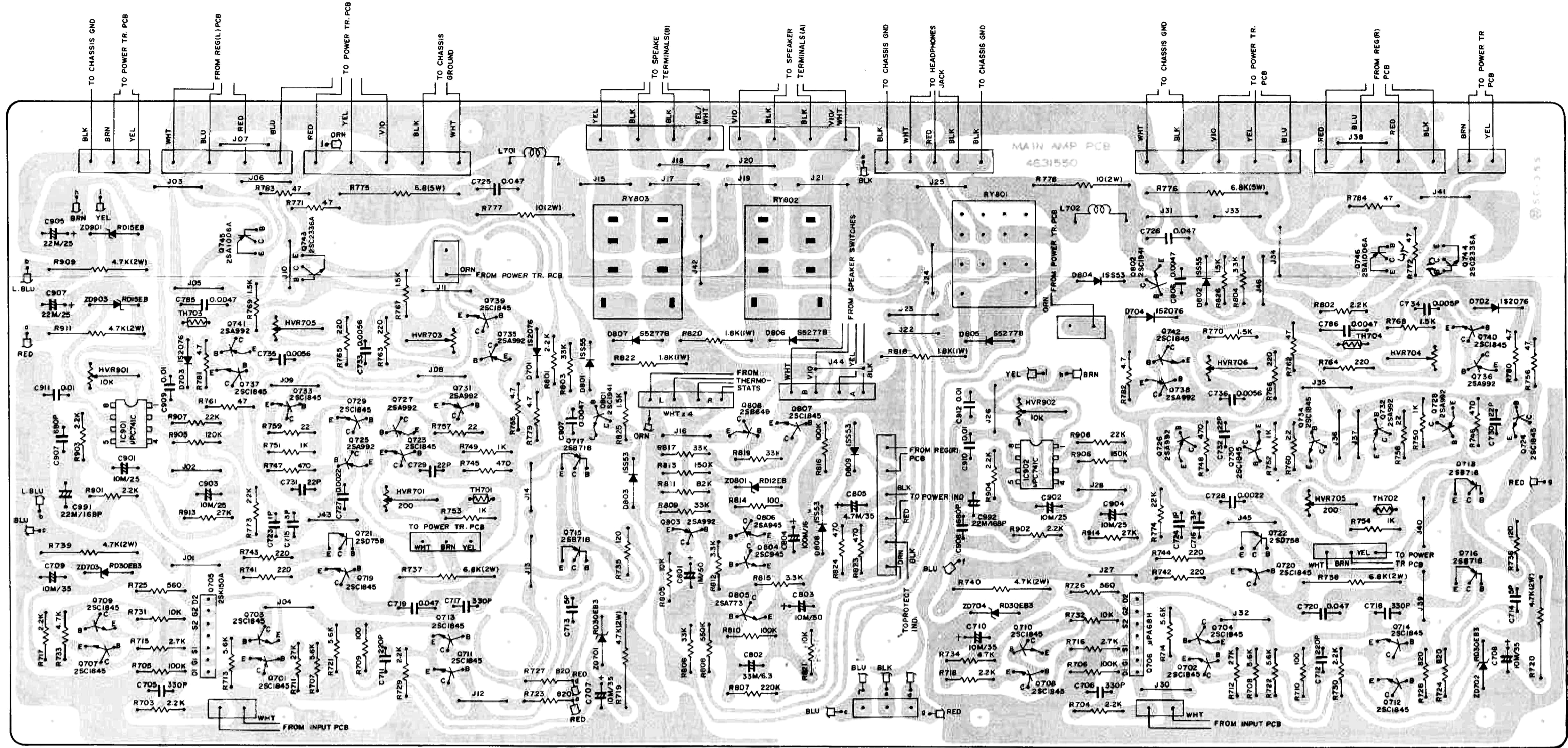
CAUTION: REFER SERVICING TO QUALIFIED SERVICE PERSONNEL.

- EACH PRECAUTION TO BE FOLLOWED DURING SERVICING.
- INDICATES SAFETY CRITICAL COMPONENTS FOR CONTINUED SAFETY. REPLACE SAFETY CRITICAL COMPONENTS ONLY WITH MANUFACTURER'S RECOMMENDED PARTS.
- BEFORE RETURNING THIS APPLIANCE TO THE CUSTOMER, YOU MAKE LEAKAGE CURRENT OR RESISTANCE MEASUREMENTS TO DETERMINE THAT EXPOSED PARTS ARE ACCEPTABLY INSULATED FROM THE SUPPLY CIRCUIT.

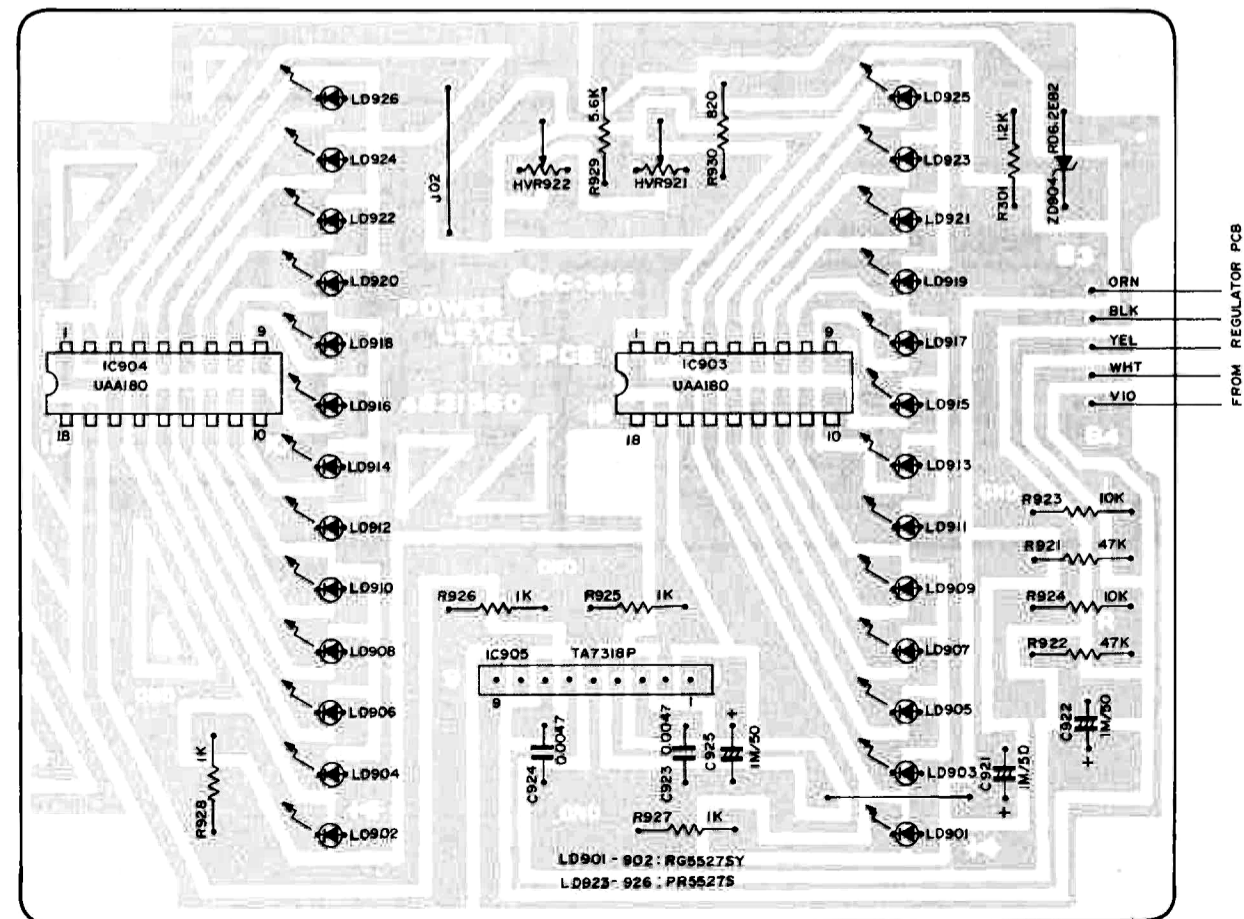
Figure 7

T-1-388 (W-TYPE)  
T-1-389 (E.B.B-TYPE)

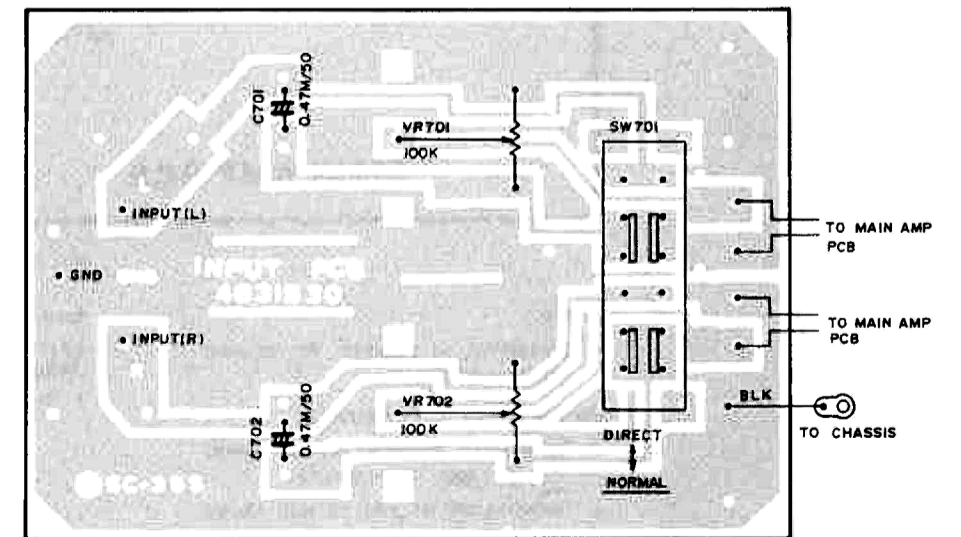
**P. C. BOARD (CONDUCTIVE SIDE VIEW) Figure 8**



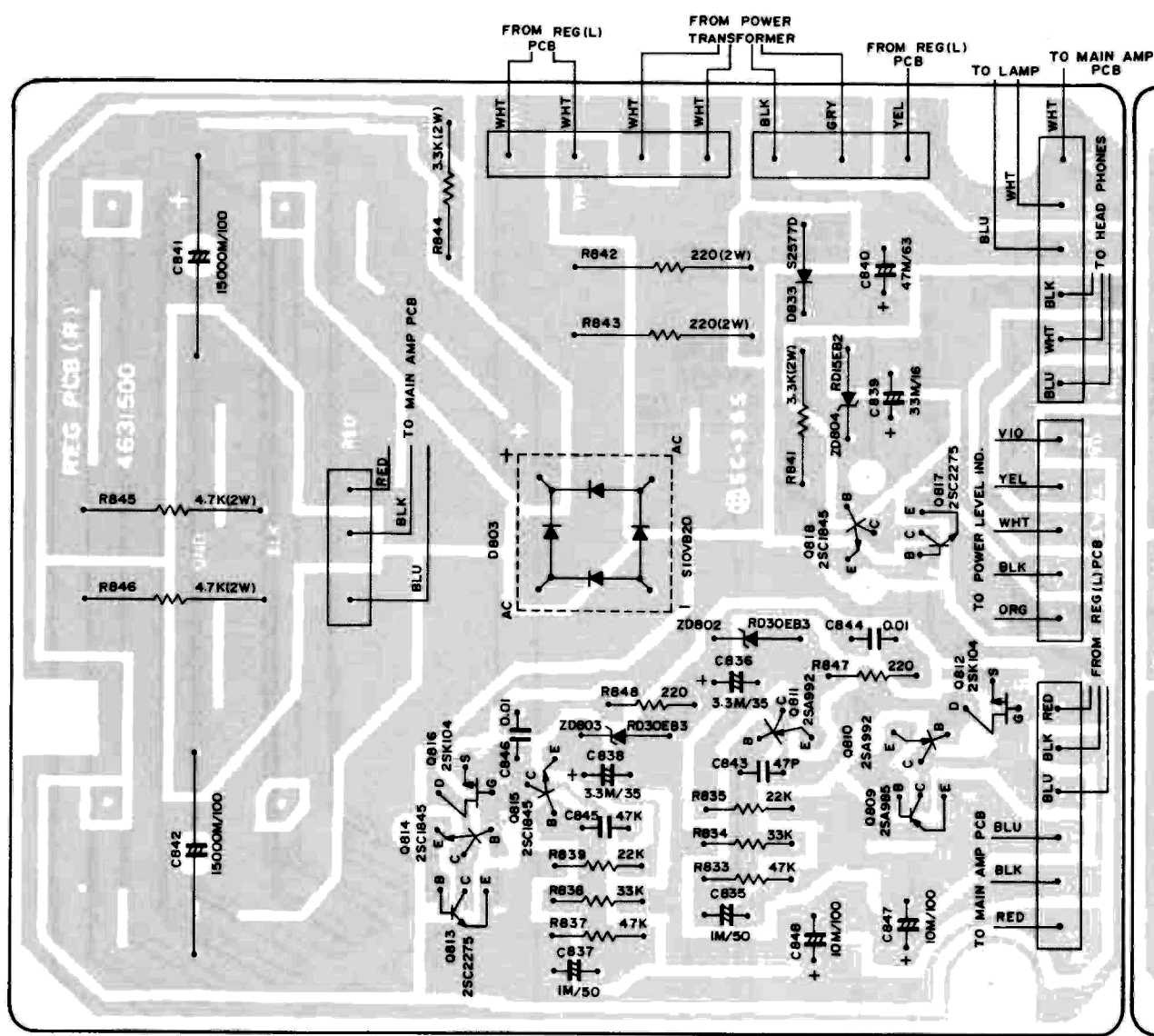
**MAIN AMP PCB**



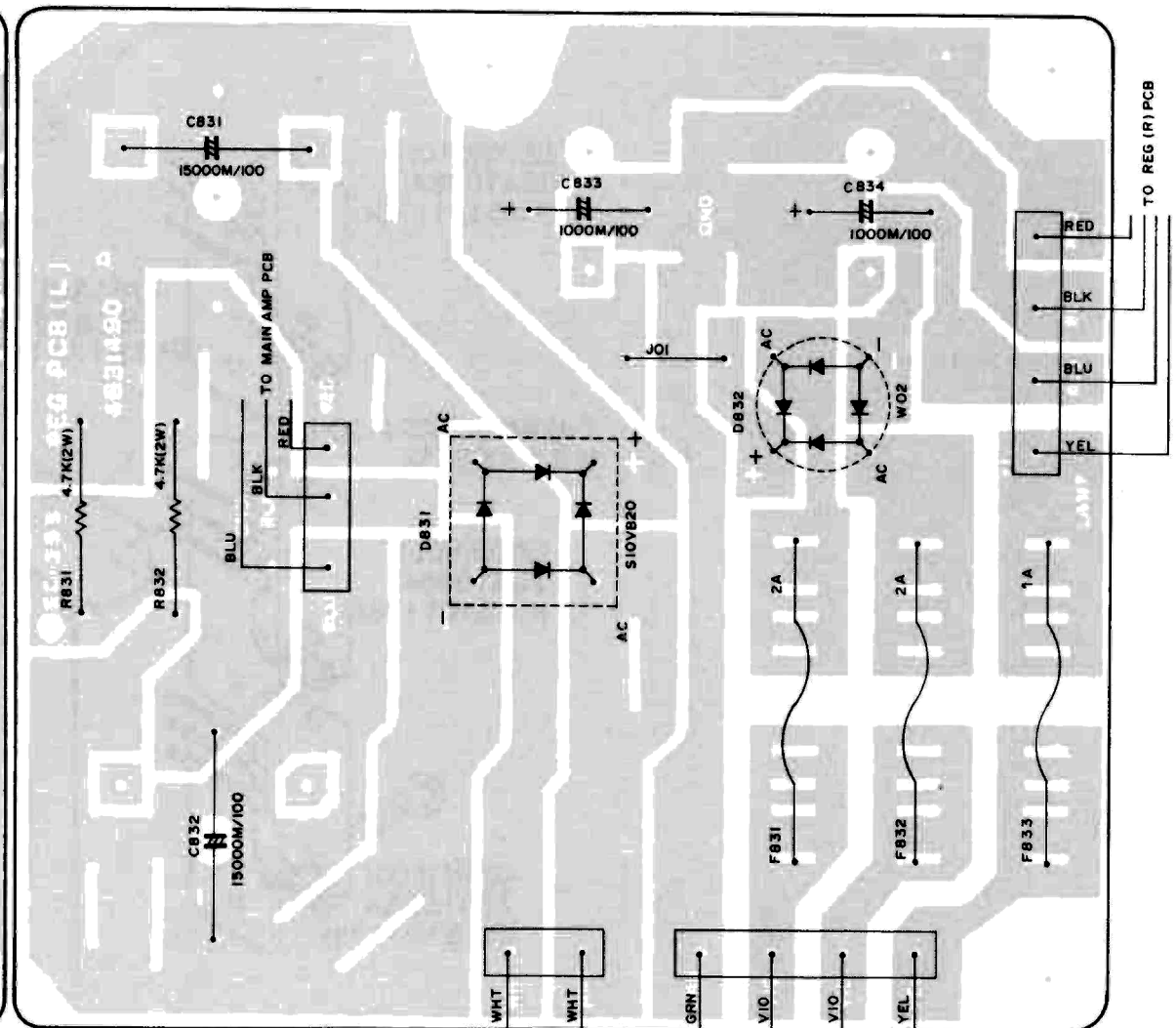
**POWER LEVEL IND. PCB**



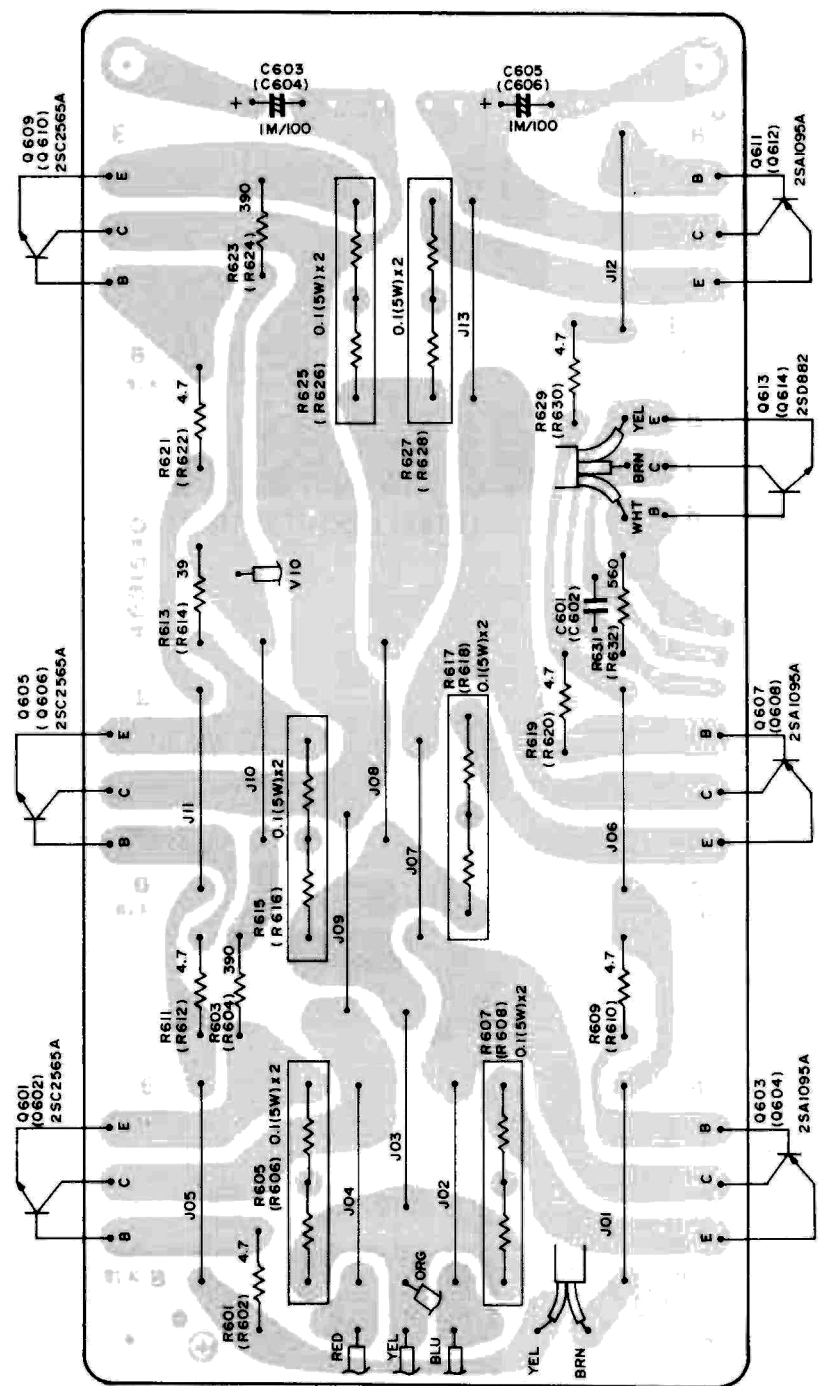
**INPUT PCB**



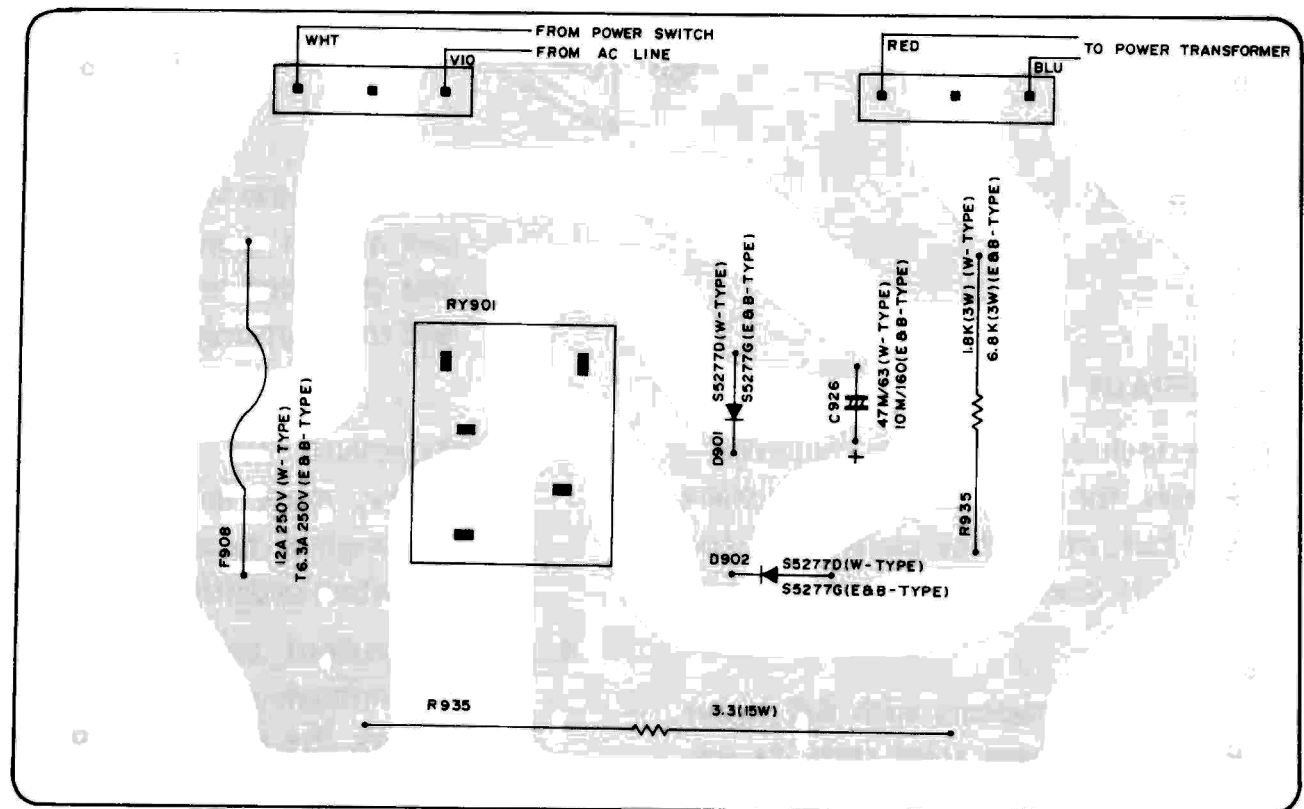
REGULATOR(R) PCB



REGULATOR(L) PCB



POWER TRANSISTORS PCB



PRIMARY RELAY PCB


# PARTS LIST

## NOTES:

1. \* The KEY NUMBER (#) marked with a (\*) on parts list relate to number of three digits with a (○). (Photo 6 ~ 9)
2. + Numerals in file indicate the quantity of parts used in one type.
3. ++ TR : Transistor  
FET : Field effect transistor  
VR : Volume control (Variable resistor)  
RES : Carbon film fixed resistor  
MO-RES : Metal oxide film fixed resistor  
CEM-RES : Cemented wirewound fixed resistor  
FP : Flame proof  
C-CAP : Ceramic capacitor  
E-CAP : Aluminum electrolytic capacitor  
M-CAP : Polyester film capacitor  
S-CAP : Polystyrene film capacitor  
T-CAP : Tantalum electrolytic capacitor  
BP-CAP : Bipolar electrolytic capacitor  
LC-CAP : Low current leakage electrolytic capacitor.

4. Assemblies and parts are subject to change without notice.
5. Parts ordering procedure:
  - A. DO NOT USE THE "KEY" NUMBER AND "SYMBOL" NUMBER. (these are control # for the factory only)
  - B. Include in any order
    - a. Part number.
    - b. Part description.
    - c. Model number.
 (any of the above lacking from an order may delay shipment of that order.)

## CAUTION:

The  mark, the KEY NO. and the SYMBOL NO. circled with rectangle in the schematic diagram and the shaded are in the parts list designate components which have special characteristics important for safety and should be replaced only with types identical to those in the original circuit or specified in the parts list.

KEY NO.	SYMBOL NO.	TYPE <sup>+</sup> W E B	DESCRIPTION <sup>++</sup>	PART NO.
<b>PACKING MATERIALS &amp; ACCESSORIES</b>				
001		1 1 1	Carton box	9826840
002		2 2 2	Pad	9840960
003		1 1 1	Sack, polyethylen cloth	9640750
004		1 1 1	Sack, polyethylen cloth - #13	9640320
005a		1 - -	Manual, instructions - English and French	960432E
005b		- 1 1	Manual, instructions - in five different languages	960432K
007a		1 - -	Card, warranty - U.S.A.	967046A
007b		1 - -	Card, warranty - Canada	967044A
008		1 - -	List, service stations	9690300
009		1 1 1	Cord, RCA phono pin plug - 2T-1	962014A
<b>CABINET ASSEMBLY</b>				
*101a		1 1 1	Panel, front - SILVER	7886540
*101b		1 1 1	Panel, front - BLACK	7886530
*102b		1 1 1	Panel, power level indicator - BLACK	7871320
*103a		2 2 2	Handle - 120G - SILVER	7490360
*103b		2 2 2	Handle - 120B - BLACK	7490210
*104		1 1 1	Window, panel	7803210
*105		1 1 1	Spacer, LED	7002130
*106		1 1 1	Globe, LED - protection indicator	7402540
*107		1 1 1	Guide, button - 1P18 - power switch	7402550
*108		1 1 1	Guide, button - 2P18 - speakers selector	7402560
*109		1 1 1	Globe, LED - input power indicator	7402120
*110a		3 3 3	Button, Push - M18GL - power/speaker, SILVER	7853940
*110b		3 3 3	Button, push - M18BK - power/speaker, BLACK	7852300
*111		1 1 1	Cover, top	7821090
112		1 1 1	Plate, bottom	7326250
*113		4 4 4	Foot, polyethylen - 30φx14	7400780
<b>CHASSIS ASSEMBLY</b>				
*201a		1 - -	Transformer, power - T-1-388 - AC120V	1103880
*201b		- 1 1	Transformer, power - T-1-389 - AC220 or 240V	1103890
*202a		1 - -	Switch, push - ESB-99354T - power	4041830
*202b		- 1 1	Switch, push - ESB 90179S - power	4041600
203a		1 1 1	C-CAP 0.0047uf	239472A
204		- 1 1	Cover, C-CAP	7400960

KEY NO.	SYMBOL NO.	TYPE <sup>+</sup> W E B	DESCRIPTION <sup>++</sup>	PART NO.
*205		1 1 1	Switch, twin push - SUF-24 - speakers	4041040
*207		1 1 1	Light guide, level indicator	7401580
*208		1 1 1	Lamp - 8V 0.3A	5808200
<b>BACK PLATE ASSEMBLY</b>				
*301a		1 - -	Plate, back - (W)	7328640
*301b		- 1 1	Plate, back - (E)	732865A
*302		2 2 2	Block, terminal guard	7402130
*303		2 2 2	Knob - P2BK-1613DL - input level	7852350
*304a		1 - -	Cord, AC line - SPT-2	806008A
*304b		- 1 -	Cord, AC line - CEE-2T	600511A
*304c		- 1 1	Cord, AC line - BS	600515A
*305a		1 - -	Bush, power cord - SR-4N-4	7400690
*305b		- 1 1	Bush, power cord - SR-6W-1	7400740
*306		1 1 1	Terminal, speakers - screw type 4P	4450490
*307		1 1 1	Shaft, GND terminal - MK-3	7152050
*308		1 1 1	Nut, GND terminal - MK-2	7152060
<b>(INPUT PCB SECTION)</b>				
*309		1 1 1	Terminal, RCA phono pin jack	4442070
*310		1 1 1	Switch, slide - SSB-042 - normal-direct selector	4020560
*311		2 2 2	VR 100kohm (B) - input level control	4310630
	C701,702	2 2 2	BP-CAP 0.47uf 50V	225505C
	R701,702	2 2 2	RES 1meg.ohm 5% 1/4W	328105J
<b>PRIMARY RELAY PC BOARD ASSEMBLY</b>				
<b>(PRIMARY RELAY SECTION)</b>				
F901		1 - -	Fuse - 12A 250V MGC	4700750
F901		- 1 1	Midget fuse - T6.3A 250V	4720490
RY901		1 - -	Relay - LY1-0-US TV-5	1700390
RY901		- 1 1	Relay - FRL 264D 100	1700400
D901,902		2 - -	Diode S5277D	560047S
D901,902		- 2 2	Diode S5277G	560069S
C926		1 - -	E-CAP 47uf 63V	211625Q
C926		- 1 1	E-CAP 10uf 160V	261120Q
C934		1 1 1	CEM-RES 3.3ohm 10% 15W	387338U

PART ORDERING PROCEDURE ----- DO NOT USE THE "KEY" NUMBER AND "SYMBOL" NUMBER. (these are control # for the factory only.) Include in any order: a. Part number, b. Part description, c. Model number. (any of the above lacking from an order may delay shipment of the order.)



KEY	SYMBOL	TYPE <sup>+</sup>	DESCRIPTION <sup>++</sup>	PART
NO.	NO.	W E B		NO.
R935	1 - -		FP-MO-RES 1.8kohm 5% 3W	363182L
R935	- 1 1		FP-MO-RES 6.8kohm 5% 3W	363682L
<b>(INPUT POWER INDICATOR SECTION)</b>				
LD928	1 1 1		LED BR5504S	5060300
	1 1 1		Spacer, LED	7903140
<b>(PROTECTION INDICATOR SECTION)</b>				
LD927	1 1 1		LED PR5527S	5060270
	1 1 1		Spacer, LED	7903270
<b>(HEADPHONES SECTION)</b>				
*401	1 1 1		Jack, headphones	4550260
R932,933	2 2 2		FP-MO-RES 390ohm 5% 2W	362391L
<b>POWER TRANSISTORS PC BOARD ASSEMBLY - LEFT CHANNEL ONLY</b>				
Q601,605, Q609	3 3 3		TR 2SC2565A (R or O or Y)	512117S
Q603,607	3 3 3		TR 2SA1095A (R or O or Y)	510117S
Q611	3 3 3		TR 2SD882 (P or Q)	513119S
Q613	1 1 1		Thermostat - OHD-120M	490094S
C603,605	2 2 2		E-CAP 1uf 100V	211810Q
C601	1 1 1		M-CAP 0.001uf 10% 50V	222102K
R601,609 R611,619, R621,629 R603,613, R623 R631 Others	6 6 6 3 3 3 1 1 1 6 6 6		FP-RES 4.7ohm 5% 1/4W FP-RES 390ohm 5% 1/4W RES 560ohm 5% 1/4W CEM-RES 0.1ohm 10% 2Wx2	328478L 328391L 328561J 382109P
<b>MAIN AMP PC BOARD ASSEMBLY</b>				
L701,702	1 1 1		Coil, choke - 1uH	1210960
IC901,902	2 2 2		IC μPC741C	518088S
Q701 ~ Q704	4 4 4		TR 2SC1845 (E or F)	512115S
Q705,706	2 2 2		FET μPA68H (L)	516050S
Q707 ~ Q714	8 8 8		TR 2SC1845 (E or F)	512115S
Q715 ~ Q718	4 4 4		TR 2SB718 (C)	511117S
Q719,720	2 2 2		TR 2SC1845 (E or F)	512115S
Q721,722	2 2 2		TR 2SD758 (C)	513120S
Q723,724	2 2 2		TR 2SC1845 (E or F)	512115S
Q725 ~ Q728	4 4 4		TR 2SA992 (E or F)	510110S
Q729,730	2 2 2		TR 2SC1845 (E or F)	512115S
Q731,732	2 2 2		TR 2SA992 (E or F)	510110S
Q733 ~ Q740	6 6 6		TR 2SC1845 (E or F)	512115S
Q743,744	2 2 2		TR 2SC2336A (P, Q)	512151S
Q745,746	2 2 2		TR 2SA1006A (P, Q)	510136S
D701 ~ D704	4 4 4		Diode 1S2076	501019S
ZD701 ~ ZD704	4 4 4		Zener diode RD30EB3	502066S
ZD901,902	2 2 2		Zener diode RD15EB2	502050S
TH701,702	2 2 2		Thermistor SDT-35	5400190

KEY	SYMBOL	TYPE <sup>+</sup>	DESCRIPTION <sup>++</sup>	PART
NO.	NO.	W E B		NO.
TH703,704	2 2 2		Thermistor D2FHL-103S	5400180
C703,704	2 2 2		E-CAP 10uf 100V	211820Q
C705,706	2 2 2		C-CAP 330p 10% 50V SL	232331K
C707 ~ C710	4 4 4		E-CAP 10uf 35V	211420Q
C711,712	2 2 2		C-CAP 220pf 10% 50V SL	232221K
C713,714	2 2 2		C-CAP 5pf ± 0.5pf 500V SL	234509D
C715,716	2 2 2		C-CAP 3pf ± 0.5pf 500V SL	237309D
C717,718	2 2 2		C-CAP 330pf 10% 50V SL	232331K
C719,720	2 2 2		M-CAP 0.047uf 10% 100V	226473K
C721,722	2 2 2		E-CAP 10uf 100V	211820Q
C723,724	2 2 2		C-CAP 1pf ± 0.5pf 500V SL	234109D
C725,726	2 2 2		M-CAP 0.047uf 10% 200V	272473K
C727,728	2 2 2		M-CAP 0.0022uf 10% 50V	222222K
C729 ~ C732	4 4 4		C-CAP 22pf 10% 50V SL	232220K
C733 ~ C736	4 4 4		M-CAP 0.0056uf 10% 50V	222562K
C785,786	2 2 2		M-CAP 0.047uf 10% 100V	226473K
C901 ~ C904	4 4 4		BP-CAP 10uf 25V	215320C
C905,907	2 2 2		E-CAP 22uf 25V	211322Q
C909 ~ C912	4 4 4		C-CAP 0.01uf +80, -20% 50V YG	231103Z
C991,992	1 1 1		BP-CAP 22u 16V	215222C
HVR701,7022	2 2 2		Potentiometer - 200ohm	4301290
HVR703,7042	2 2 2		Potentiometer - 1kohm	4301300
HVR901,9022	2 2 2		Potentiometer - 10kohm	4301280
R703,704	2 2 2		RES 2.2kohm 5% 1/4W	328222J
R705,706	2 2 2		RES 100kohm 5% 1/4W	328104J
R707,708	2 2 2		RES 5.6kohm 5% 1/4W	328562J
R711 ~ R714	4 4 4		RES 27kohm 5% 1/4W	328273J
R715,716	2 2 2		RES 2.7kohm 5% 1/4W	328272J
R717,718	2 2 2		RES 2.2kohm 5% 1/4W	328222J
R719,720	2 2 2		FP-MO-RES 4.7kohm 5% 2W	362472L
R721,722	2 2 2		RES 5.6kohm 5% 1/4W	328562J
R723,724	2 2 2		RES 820ohm 5% 1/4W	328821J
R725,726	2 2 2		RES 560ohm 5% 1/4W	328561J
R727,728	2 2 2		RES 820ohm 5% 1/4W	328821J
R729,730	2 2 2		RES 2.2kohm 5% 1/4W	328222J
R731,732	2 2 2		RES 10kohm 5% 1/4W	328103J
R733,734	2 2 2		RES 4.7kohm 5% 1/4W	328472L
R735,736	2 2 2		FP-RES 120ohm 5% 1/4W	328121L
R737,738	2 2 2		FP-MO-RES 6.8kohm 5% 2W	362682L
R739,740	2 2 2		FP-MO-RES 4.7kohm 5% 2W	362472L
R741 ~ R744	4 4 4		FP-RES 220ohm 5% 1/4W	328221L
R745 ~ R748	4 4 4		RES 470ohm 5% 1/4W	328471J
R749 ~ R752	4 4 4		RES 1kohm 5% 1/4W	328102J
R755,756	2 2 2		FP-RES 47ohm 5% 1/4W	328470L
R757 ~ R760	4 4 4		RES 22ohm 5% 1/4W	328220J
R761,762	2 2 2		FP-MO-RES 47ohm 5% 1/4W	328470L
R763 ~ R766	4 4 4		RES 220ohm 5% 1/4W	328222L
R767 ~ R770	4 4 4		RES 1.5kohm 5% 1/4W	328152J
R771,772	2 2 2		FP-MO-RES 150ohm 5% 1W	361150L
R777,778	2 2 2		FP-MO-RES 10ohm 5% 2W	362100L
R775,776	2 2 2		CEM-RES 6.8ohm 10% 5W	384688K
R797,798	2 2 2		RES 22kohm 5% 1/4W	328223J
R901 ~ R904	4 4 4		RES 2.2kohm 5% 1/4W	328222J
R905,906	2 2 2		RES 120kohm 5% 1/4W	328124J
R907,908	2 2 2		RES 22kohm 5% 1/4W	328223J
R909,911	2 2 2		FP-MO-RES 4.7kohm 5% 2W	362472L

PART ORDERING PROCEDURE - - - - DO NOT USE THE "KEY" NUMBER AND "SYMBOL" NUMBER. (these are control # for the factory only.)  
 order: a. Part number, b. Part description, c. Model number. (any of the above lacking from an order may delay shipment of the order.)

Include in any

KEY NO.	SYMBOL NO.	TYPE <sup>+</sup> W E B	DESCRIPTION <sup>++</sup>	PART NO.
<b>(PROTECTOR SECTION)</b>				
	RY801	1 1 1	Relay - DC48V	1700380
	RY802,803	2 2 2	Relay - DC48V	1700330
		4 4 4	Magnet - 1285	7903170
	Q801,802	2 2 2	TR 2SC1941 (L or K)	512112S
	Q803	1 1 1	TR 2SA992 (E or F)	510220S
	Q804,806	2 2 2	TR 2SC945L (P or Q)	515077S
	Q805	1 1 1	TR 2SA733A (P or Q)	514074S
	Q807	1 1 1	TR 2SC2240 (BL)	512116S
	Q808	1 1 1	TR 2SB649 (B or C)	511111S
	D801,802	2 2 2	Diode 1SS55	501024S
	D803,804	2 2 2	Diode 1SS53	501023S
	D805			
	~ D807	3 3 3	Diode S5277B	560046S
	D808,809	2 2 2	Diode 1SS53	501023S
	ZD801	1 1 1	Zener diode RD12EB3	502058S
	C801	1 1 1	E-CAP 1uf 50V	211510Q
	C802	1 1 1	BP-CAP 33uf 6.3V	215053C
	C803,804	2 2 2	E-CAP 100uf 16V	211230Q
	C805	1 1 1	E-CAP 10uf 50V	211520Q
	C806	1 1 1	E-CAP 4.7uf 35V	211415Q
<b>REGULATOR (L) PC BOARD ASSEMBLY</b>				
	F831,832	2 - -	Fuse - 2A 250V MGC	4700620
	F833	1 - -	Fuse - 1A 250V MGC	4700590
	F831,832	- 2 2	Midget fuse - T2A 250V	4720370
	F833	- 1 1	Midget fuse - T1A 250V	4720330
	D831	1 1 1	Diode S10VB20	560058S
	D832	1 1 1	Diode W02	560061S
	C831,832	2 2 2	E-CAP 15000uf 100V	2100100
	C833,834	2 2 2	E-CAP 1000uf 100V	2100110
	R813,832	1 1 1	FP-MO-RES 4.7kohm 5% 2W	362472L
<b>REGULATOR (R) PC BOARD ASSEMBLY</b>				
	Q809	1 1 1	TR 2SA985 (P or Q)	510118S
	Q810,811	2 2 2	TR 2SA992 (E or F)	510110S

KEY NO.	SYMBOL NO.	TYPE <sup>+</sup> W E B	DESCRIPTION <sup>++</sup>	PART NO.
	Q812	1 1 1	FET 2SK104 (F)	516026S
	Q813	1 1 1	TR 2SC2275 (P or Q)	512120S
	Q814,815	2 2 2	TR 2SC1845 (E or F)	512115S
	Q816	1 1 1	FET 2SK104 (F)	516026S
	Q817	1 1 1	TR 2SC2275 (P or Q)	512120S
	Q818	1 1 1	TR 2SC1845 (E or F)	512115S
	D802,803	2 2 2	Zener diode RD30EB3	502066S
	D804	1 1 1	Zener diode RD15EB2	502050S
	D833	1 1 1	Diode S5277B	560046S
	D834	1 1 1	Diode S10VB20	560058S
	C835,837	2 2 2	E-CAP 1uf 50V	211510Q
	C836,837	2 2 2	E-CAP 3.3uf 35V	211413Q
	C839	1 1 1	E-CAP 33uf 16V	211223Q
	C840	1 1 1	E-CAP 47uf 63V	211625Q
	C841,842	2 2 2	E-CAP 15000uf 100V	2100100
	R833,837	1 1 1	RES 47kohm 5% ¼W	328473J
	R834,838	1 1 1	RES 33kohm 5% ¼W	328333J
	R835,839	1 1 1	RES 22kohm 5% ¼W	328223J
	R841	1 1 1	FP-MO-RES 3.3kohm 5% 2W	362332L
	R842,843	2 2 2	FP-MO-RES 220ohm 5% 2W	362221L
	R844	1 1 1	FP-MO-RES 4.7kohm 5% 1W	361472L
	R845,846	2 2 2	FP-MO-RES 4.7kohm 5% 2W	362472L
<b>POWER LEVEL INDICATOR PCB ASSEMBLY</b>				
	IC903,904	2 2 2	IC UAA180	518066S
	IC905	1 1 1	IC TA7318P	518067S
	ZD904	1 1 1	Zener diode RD6.2EB2	502048S
	LD901			
	~ LD922	22 22 22	LED PG5527SY - green	5060280
	LD923			
	~ LD926	4 4 4	LED PR5527S - red	5060270
	C921,922	2 2 2	E-CAP 1uf 50V	211510Q
	C923,924	2 2 2	M-CAP 0.0047uf 10% 50V	222472K
	C925	1 1 1	E-CAP 1uf 50V	211510Q
	HVR921,922	2 2 2	Potentiometer - 3kohm	4301340
	R921,922	2 2 2	RES 47kohm 5% ¼W	328473J
	R923,924	2 2 2	RES 10kohm 5% ¼W	328103J
	R925			
	~ R928	4 4 4	RES 1kohm 5% ¼W	328102J
	R929	1 1 1	RES 820ohm 5% ¼W	328820J
	R930	1 1 1	RES 3.3kohm 5% ¼W	328322J
	R931	1 1 1	RES 1.2kohm 5% ¼W	328122J

# SEMICONDUCTOR DATA

## TRANSISTORS

† NOTES

Ge: Germanium  
Si: Silicon

A: Alloy  
B: Base  
D: Diffused  
Dd: Double-diffused

Df: Drift-field  
E: Epitaxial  
G: Grown  
J: Junction

M: Mesa  
P: Planar  
Pc: Point-contact  
Td: Triple-diffused

DEVICE TYPE	APPLICATIONS	STRUCTURE†	MAXIMUM RATINGS Absolute-Maximum Values: (TA = 25°C unless otherwise specified)					ELECTRICAL CHARACTERISTICS Typical Values: (TA = 25°C unless otherwise specified)														MANUFACTURER
			Collector-to-Base Voltage VCB0 (V)	Emitter-to-Base Voltage VEB0 (V)	Collector Current IC (mA)	Collector Dissipation PC (mW)	Junction Temperature TJ (°C)	Collector Cutoff Current ICBO (uA)	VCE (V)	hFE	VCE (V)	IC (mA)	VCE(sat) (V)	IC (mA)	IB (mA)	fT (MHz)	VCE (V)	IE (mA)	Output Capacitance Cob (pF)	Others		
2SA733A (P, Q)	AF, General	PNP Si-E	-60	-5	-100	250	125	-0.1 max.	-60	135 ~ 400	-6	-1	-0.3 max.	-100	-10	450 max.	-6	10	6 max.		NEC	
2SA985 (P, Q)	AF, Power, amp.	PNP Si-E	-120	-5	-1.5A	25W (Tc=25°C)	150	-1 max.	-120	100 ~ 320	-5	-300	-2 max.	-1A	-100	180	-5	-200*	29	Complementary to 2SC2275	NEC	
2SA992 (E, F)	AF, Low noise	PNP Si-E	-120	-5	-50	500	125	-0.05 max.	-120	300 ~ 800	-5	-1	0.3 max.	-10	-1	100	-6	1	3 max.	Complementary to 2SC1845	NEC	
2SA1095A (R, O, Y)	AF, Power amp.	PNP Si-E	-180	-5	-15A	150W (Tc=25°C)	150	-50 max.	-180	55 ~ 240	-5	-1A	-2 max.	-5A	-500	60	-10	-1A*	350	Complementary to 2SC2565A	TOSHIBA	
2SB649 (B, C)	AF, Driver	PNP Si-E	-180	-5	1.5A	20W (Tc=25°C)	150	-10 max.	-180	60 ~ 200	-5	-150	-1 max.	-500	-50	140	-5	150*	27		HITACHI	
2SA1006A (C)	PA	PNP Si-E	-200	-5.0	-1.5	25W (Tc=25°C)	150	-1	-150	100 ~ 320	-5.0	-150	-0.4	-500	-50	80	-10	-0.1A		Complementary to 2SC2336A	NEC	
2SB718 (C)	AF, Driver	PNP Si-E	-200	-5	-50	1250	150	-10 max.	-160	100 ~ 200	-5	-10	-2 max.	-30	-3	140	-5	-10*	5.5	Complementary to 2SD758	HITACHI	
2SC945L (P, Q)	AF, General	NPN Si-E	60	5	100	250	125	0.1 max.	60	135 ~ 400	6	1	0.3 max.	100	10	450 max.	6	-10	5 max.		NEC	
2SC1845 (E, F)	AF, Low noise	NPN Si-E	120	5	50	500	125	0.05 max.	120	300 ~ 800	6	1	0.3 max.	01	1	110	6	-1	2.5 max.	Complementary to 2SC1892	NEC	
2SC1941 (L, K)	AF, Driver	NPN Si-E	160	5	50	800	150	0.1 max.	160	135 ~ 400	10	1	0.6 max.	20	2	120	10	-10	3 max.		NEC	
2SC2275 (P, Q)	AF, Power amp.	NPN Si-E	120	5	1.5A	25W (Tc=25°C)	150	1 max.	120	100 ~ 320	5	300	2 max.	1A	100	200	5	200*	19	Complementary to 2SA985	NEC	
2SC2565A (R, O, Y)	AF, Power amp.	NPN Si-E	180	5	15A	150W (Tc=25°C)	150	50 max.	160	55 ~ 240	5	1A	2 max.	5A	500	80	10	1A*	200	Complementary to 2SA1095A	TOSHIBA	
2SC2336A (C)	PA	NPN Si-E	200	5.0	1.5	25W (Tc=25°C)	150	1.0	150	100 ~ 320	5.0	150	0.3	500	50	95	10	0.1A		Complementary to 2SA1006A	NEC	
2SD758 (C)	AF, Driver	NPN Si-E	200	5	50	1250	150	10 max.	160	100 ~ 200	5	10	2 max.	30	3	140	5	10*	3.8	Complementary to 2SB718	HITACHI	
2SD882 (P, Q)	AF	NPN Si-E	40	5	3A	10W (Tc=25°C)	150	1	30	100 ~ 320	2	20	0.5 max.	2A	200	90	5	-100	45		NEC	

## FIELD EFFECT TRANSISTOR

DEVICE TYPE	APPLICATIONS	STRUCTURE†	MAXIMUM RATINGS Absolute-Maximum Values: (TA = 25°C unless otherwise specified)					ELECTRICAL CHARACTERISTICS Typical Values: (TA = 25°C unless otherwise specified)											MANUFACTURER		
			Gate-to-Drain Voltage VGS0 (V)	Gate-to-Source Voltage VGS0 (V)	Gate Current IG (mA)	Drain Current ID (mA)	Total Dissipation PD (mW)	Channel Temperature Tch (°C)	Gate Leak Current IGS (nA)	Gate to Drain Breakdown Voltage VGS0 (V)	Drain Current IDSS (mA)	Gate to Source Cutoff Voltage VGS (V)	Forward Transfer Admittance  Yfs  (mS)	Feed Back Capacitance Coss (pF)	Power Gain (Common Source) Gps (dB)	Noise Figure NF (dB)					
2PAG6H (L)	AF, Low noise Differential amp.	Si N-channel junction (Dual)	-50	-50	10	200/unit	125	VGS = -30V VDS = 0	-1 max.		VGS = 10V VDS = 0	2.8 ~ 6.5		VGS = 10V VDS = 0 f = 1 kHz IDSS = 3mA	12	VGS = 10V ID = 0 f = 1 MHz	3		VGS = 10V ID = 1 mA f = 1 kHz	2 max.	TOSHIBA

## DIODES, LED'S

DEVICE TYPE	APPLICATIONS	STRUCTURE†	MAXIMUM RATINGS Absolute - Maximum Values: (TA = 25°C unless otherwise specified)							ELECTRICAL CHARACTERISTICS Typical Values: (TA = 25°C unless otherwise specified)							MANUFACTURER	
			Reverse Surge Voltage VR (V)	Peak Reverse Voltage VRM (V)	Reverse Voltage VR (V)	Peak Forward Voltage VFM (V)	Peak Forward Current IFM (mA)	Average Rectified Current IO (mA)	Forward Surge Current IF surge (A)	Junction Temperature TJ (°C)	Total Power Dissipation PD (mW)	Forward Current IFmin (mA)	Test Condition VF (V)	Forward Voltage VFmax (V)	Test Condition IF (mA)	Reverse Current IRmax (uA)		Test Condition VR (V)
1SS53	Medium speed switching	Si-EP	35	30		300	100	2	200	500		0.8	1.0	0.1	30		NEC	
1SS55	Medium speed switching	Si-EP	100	75		300	100	2	200	500		0.8	1.0	0.1	75		NEC	
5S277B	Rectifier	Si-DJ			100			2.0A	1.0A	50A	150		1.2	1.0A	10	100		TOSHIBA
5S277D	Rectifier	Si-DJ			200			2.0A	1.0A	50A	150		1.2	1.0A	10	200		TOSHIBA
5S277G	Rectifier	Si-DJ			400			2.0A	1.0A	50A	150		1.2	1.0A	10	400		TOSHIBA
W02	Rectifier	Si-DJ (Bridge)			200	200		1.5A	50	125		1.0	1.0A	10			Rth = 50°C/W	GENERAL INSTRUMENT
S10VB-20	Rectifier	Si-DJ (Bridge)			200			10A	200	150		1.05		10				SHINDENGEN
PR-5527S	Lamp (red)	Gap		4		100	IF = 30		85	75		2.5	10	100	4		IV = 1.2 mcd (IF = 10 mA)	STANLEY
PR-5527SV	Lamp (green)	Gap		4		100	IF = 50		85	125		2.5	10	100	4		IV = 8 mcd (IF = 20 mA)	STANLEY
BR-5504S	Lamp (red)	GaAlAs		4		300	IF = 50		85	100		2.0	20	100	4		IV = 80 mcd (IF = 20 mA)	STANLEY

## ZENER DIODES

DEVICE TYPE	APPLICATIONS	STRUCTURE†	MAXIMUM RATINGS Absolute - Maximum Values: (TA = 25°C unless otherwise specified)			ELECTRICAL CHARACTERISTICS Typical Values: (TA = 25°C unless otherwise specified)										MANUFACTURER
			Total Power Dissipation PD (mW)	Zener Current IZ (A)	Junction Temperature TJ (°C)	Zener Voltage VZ			Differential Resistance rZ		Temperature Coefficient γZ		Reverse Current IZ		Others	
			MIN (V)	TYP (V)	MAX (V)	IZ (mA)	TYP (Ω)	MAX (Ω)	IZ (mA)	TYP (%/°C)	MAX (%/°C)	IZ (uA)	MAX (uA)	VR (V)		
RD6.2 EB2	Regulator	Si-J	400		175	5.96	6.27	20	20	20		5	3		NEC	
RD15 EB2	Regulator	Si-J	400		175	13.89	14.62	10	30	10		2	11		NEC	
RD30 EB3	Regulator	Si-J	400		175	28.36	29.82	5	130	5		2	23		NEC	

**INTEGRATED CIRCUITS  $\mu$ PC741C**

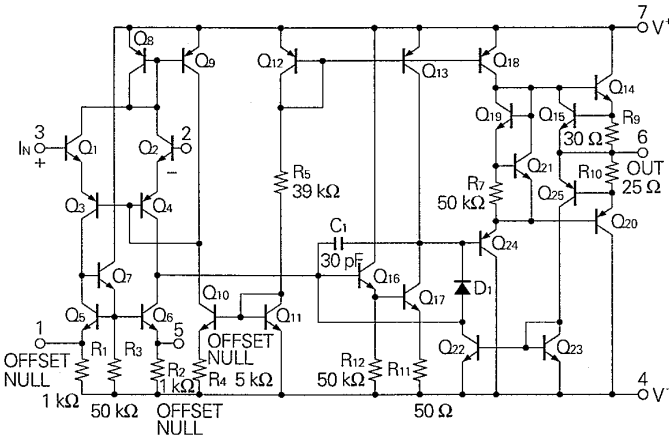
**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage	$\pm 18$ V	Input Voltage	$\pm 15$ V
Internal Power Dissipation	350 mW	Storage Temperature Range	$-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$
Differential Input Voltage	$\pm 30$ V	Operating Temperature Range	$-20^{\circ}\text{C}$ to $+75^{\circ}\text{C}$

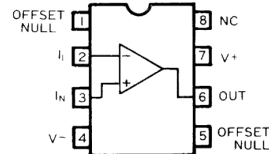
**ELECTRICAL CHARACTERISTICS** ( $V_{CC} = \pm 15\text{V}$ ,  $T_A = +25^{\circ}\text{C}$  unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Input Offset Voltage	$R_S \leq 10\text{ k}\Omega$		1.0	6.0	mV
Input Offset Current			20	200	nA
Input Bias Current			80	500	nA
Large-Signal Voltage Gain	$R_L \geq 2\text{ k}\Omega$ $V_{out} = \pm 10\text{V}$	108	106		dB
Output Voltage Swing	$R_L \geq 10\text{ k}\Omega$	12	$\pm 14$		V
Common Mode Rejection Ratio	$R_S \leq 10\text{ k}\Omega$	70	90		dB
Supply Voltage Rejection Ratio	$R_S \leq 10\text{ k}\Omega$		30	150	$\mu\text{V/V}$
Power Consumption			45	85	mW

**EQUIVALENT CIRCUIT**



**TERMINAL GUIDE (TOP VIEW)**

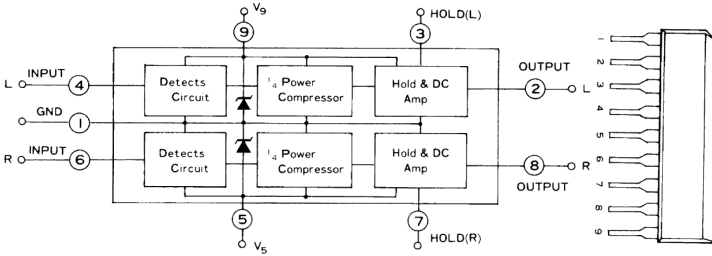


**INTEGRATED CIRCUITS TA7318P**

**FUNCTION/MANUFACTURER**

- Dual Linear-to-Log Converter for Peak Power Indicator/Toshiba

**BLOCK DIAGRAM AND CONNECTION INFORMATION**



**INTEGRATED CIRCUITS UAA180**

**FUNCTION/MANUFACTURER**

- Analog-to-Digital Converter; 12 LED Driver/Siemens

**BLOCK DIAGRAM AND CONNECTION INFORMATION**

